

INTERNATIONAL  
GEMOLOGICAL  
INSTITUTE

ELECTRONIC COPY

LABORATORY GROWN DIAMOND REPORT

June 19, 2025

IGI Report Number

DESCRIPTION

Shape and Cutting Style

Measurements

GRADING RESULTS

Carat Weight

Color Grade

Clarity Grade

ADDITIONAL GRADING INFORMATION

Polish

Symmetry

Fluorescence

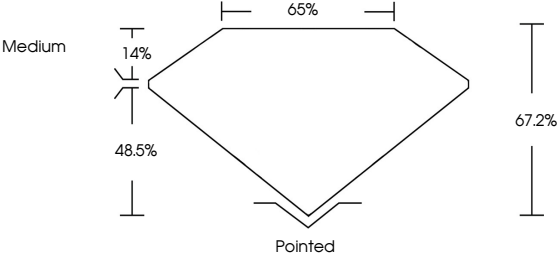
Inscription(s)


Comments: As Grown - No indication of post-growth treatment.  
This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process.  
Type II

LG717509026

Report verification at [igi.org](https://www.igi.org)

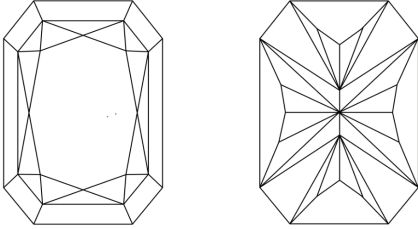
PROPORTIONS





Sample Image Used

CLARITY CHARACTERISTICS



KEY TO SYMBOLS

Red symbols indicate internal characteristics.  
Green symbols indicate external characteristics.

COLOR

D	E	F	G	H	I	J	Faint	Very Light	Light
---	---	---	---	---	---	---	-------	------------	-------

CLARITY

IF	VS <sup>1-2</sup>	VS <sup>1-2</sup>	SI <sup>1-2</sup>	I <sup>1-3</sup>
Internally Flawless	Very Very Slightly Included	Very Slightly Included	Slightly Included	Included

ADDITIONAL GRADING INFORMATION


Polish

Symmetry

Fluorescence

Inscription(s)

Comments: As Grown - No indication of post-growth treatment.  
This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process.  
Type II



IGI

June 19, 2025

IGI Report No LG717509026

CUT CORNERED RECT. MODIFIED BRILLIANT

7.86 X 5.64 X 3.79 MM

1.51 CARAT

D

VVS 1

67.2%

65%

Medium

Pointed



EXCELLENT

EXCELLENT

NONE


IGI LG717509026

Comments: As Grown - No indication of post-growth treatment.  
This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process.  
Type II



© IGI 2020, International Gemological Institute

FD - 10 20



THIS DOCUMENT WAS PRODUCED WITH THE FOLLOWING SECURITY MEASURES: SPECIAL DOCUMENT PAPER, INK SCREENS, WATERMARK BACKGROUND DESIGNS, HOLOGRAM AND OTHER SECURITY FEATURES NOT LISTED AND DO EXCEED DOCUMENT SECURITY INDUSTRY GUIDELINES.